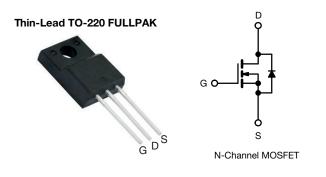
# SiHA15N80AE

**Vishay Siliconix** 



## **E Series Power MOSFET**



PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	850			
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.304		
Q <sub>g</sub> max. (nC)	53			
Q <sub>gs</sub> (nC)	8			
Q <sub>gd</sub> (nC)	16			
Configuration	Single			

### FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C<sub>o(er)</sub>)
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free and halogen-free	SiHA15N80AE-GE3

ABSOLUTE MAXIMUM RATINGS					· · · · · · · · · · · · · · · · · · ·
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V <sub>DS</sub>	800	v
Gate-source voltage			V <sub>GS</sub>	± 30	v
Continuous drain current (T <sub>J</sub> = 150 °C) $^{e}$	Vec at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	– I <sub>D</sub>	6	
	VGS at 10 V	T <sub>C</sub> = 100 °C		4	А
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	29	
Linear derating factor				0.26	W/°C
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	28	mJ
Maximum power dissipation			PD	33	W
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope		T <sub>J</sub> = 125 °C	al / alt	100	
Reverse diode dv/dt <sup>d</sup>			dv/dt	14	V/ns
Soldering recommendations (peak temperature	e) c	For 10 s		260	°C
Mounting torque, M3 screw		•		0.6	Nm

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 140 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega,$   $I_{AS}$  = 1.4 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D$ , di/dt = 100 A/µs, starting  $T_J$  = 25 °C

e. Limited by maximum junction temperature

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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	-		65				
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	- 3.8			- °C/W		
		•	•					
SPECIFICATIONS (T <sub>J</sub> = 25 °C,	unless otherw	ise noted)						
PARAMETER	SYMBOL			ONS	MIN.	TYP.	MAX.	UNI
Static							L	L
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 µA		800	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I	$_{\rm D} = 1  \rm{mA}$	-	0.8	-	V/°(
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>		$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		2	-	4	V
		,	$V_{GS} = \pm 20 V$ $V_{GS} = \pm 30 V$		-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	,			-	-	± 1	μA
7	,		= 800 V, V <sub>GS</sub>		-	-	1	
Zero gate voltage drain current	voltage drain current $I_{DSS}$ $V_{DS} = 640 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$		T <sub>J</sub> = 125 °C	-	-	10	μA	
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> =	= 7.5 A	-	0.304	0.350	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> :	= 10 V, I <sub>D</sub> = 7	'.5 A	-	5.9	-	S
Dynamic					•	•		
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz $V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$		-	1093	-	pF	
Output capacitance	C <sub>oss</sub>			-	49	-		
Reverse transfer capacitance	C <sub>rss</sub>			-	5	-		
Effective output capacitance, energy related	C <sub>o(er)</sub>			-	35	-		
Effective output capacitance, time related	C <sub>o(tr)</sub>			-	212	-		
Total gate charge	Qg	V <sub>GS</sub> = 10 V I <sub>D</sub> = 7.5 A, V <sub>DS</sub> = 640 V		-	35	53	nC	
Gate-source charge	Q <sub>gs</sub>			-	8	-		
Gate-drain charge	Q <sub>gd</sub>				-	16	-	
Turn-on delay time	t <sub>d(on)</sub>	$V_{DD}$ = 640 V, I <sub>D</sub> = 7.5 A, V <sub>GS</sub> = 10 V, R <sub>g</sub> = 9.1 Ω		-	15	30		
Rise time	t <sub>r</sub>			-	22	44	- ns	
Turn-off delay time	t <sub>d(off)</sub>			-	35	70		
Fall time	t <sub>f</sub>			-	30	60		
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain		0.2	0.5	1.1	Ω	
Drain-Source Body Diode Characteris								
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	13	A	
Pulsed diode forward current	I <sub>SM</sub>			-	-	29		
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 7.5 A, V <sub>GS</sub> = 0 V		-	-	1.2	V	
Reverse recovery time	t <sub>rr</sub>	$T_{\rm J} = 25 ^{\circ}\text{C}, I_{\rm F} = I_{\rm S} = 7.5 \text{A},$ di/dt = 100 A/µs, V <sub>R</sub> = 25 V		-	333	666	ns	
Reverse recovery charge	Q <sub>rr</sub>			-	3.7	7.4	μ	
Reverse recovery current	I <sub>RRM</sub>			-	19	-	A	

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

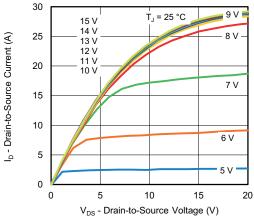


Fig. 1 - Typical Output Characteristics

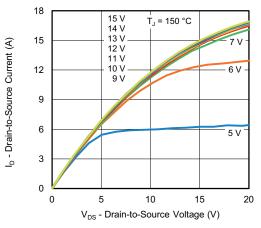


Fig. 2 - Typical Output Characteristics

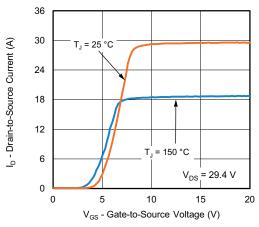


Fig. 3 - Typical Transfer Characteristics

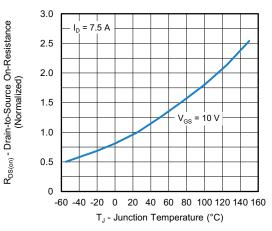


Fig. 4 - Normalized On-Resistance vs. Temperature

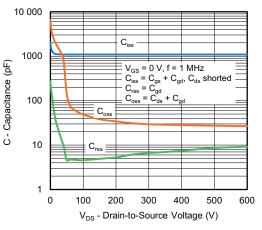
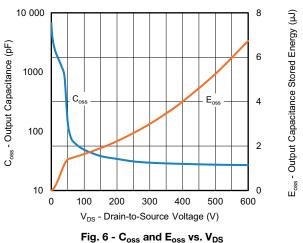


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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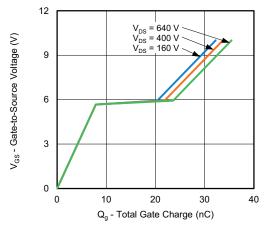


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

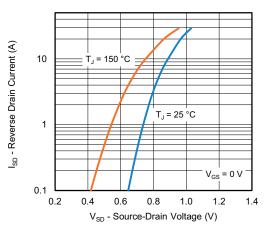


Fig. 8 - Typical Source-Drain Diode Forward Voltage

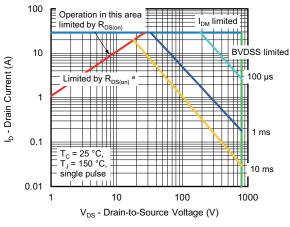


Fig. 9 - Maximum Safe Operating Area

6 4 2 0 25 50 75 100 125 150 T<sub>c</sub> - Case Temperature (°C)

8

l<sub>D</sub> - Drain Current (A)

Fig. 10 - Maximum Drain Current vs. Case Temperature

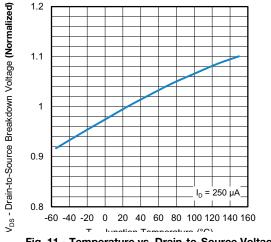


Fig. 11 - Temperature vs. Drain-to-Source Voltage

Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

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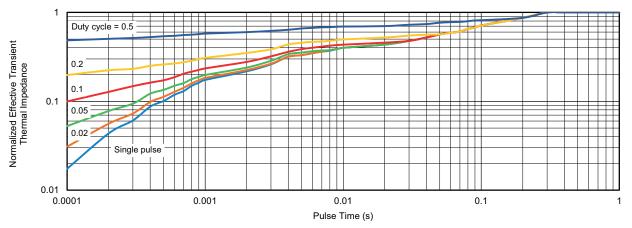


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

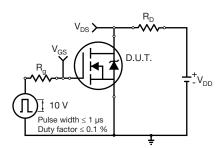


Fig. 13 - Switching Time Test Circuit

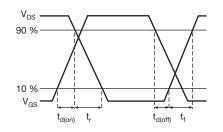


Fig. 14 - Switching Time Waveforms

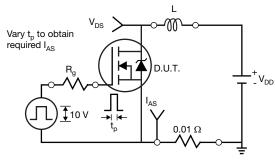


Fig. 15 - Unclamped Inductive Test Circuit

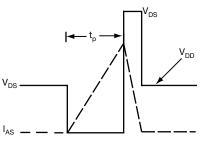


Fig. 16 - Unclamped Inductive Waveforms

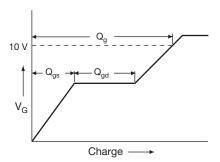
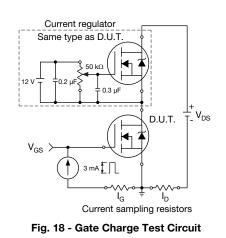


Fig. 17 - Basic Gate Charge Waveform

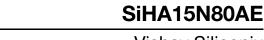


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#### Peak Diode Recovery dv/dt Test Circuit

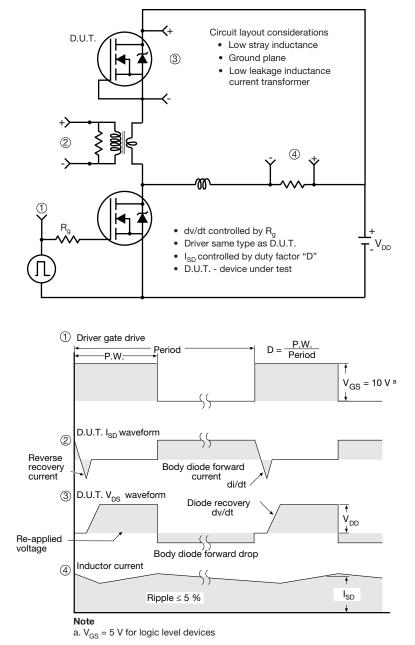


Fig. 19 - For N-Channel

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